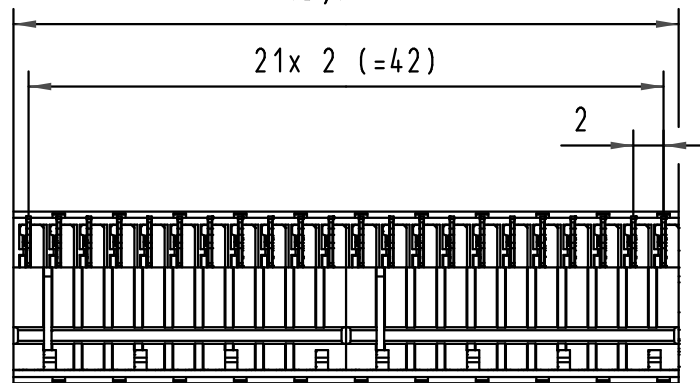
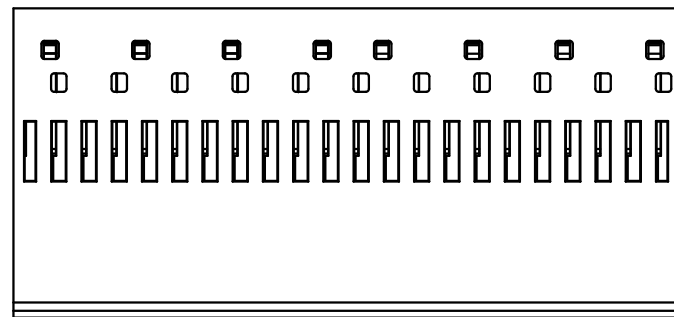
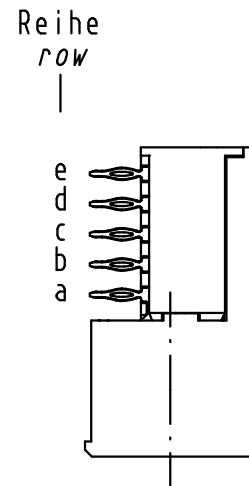
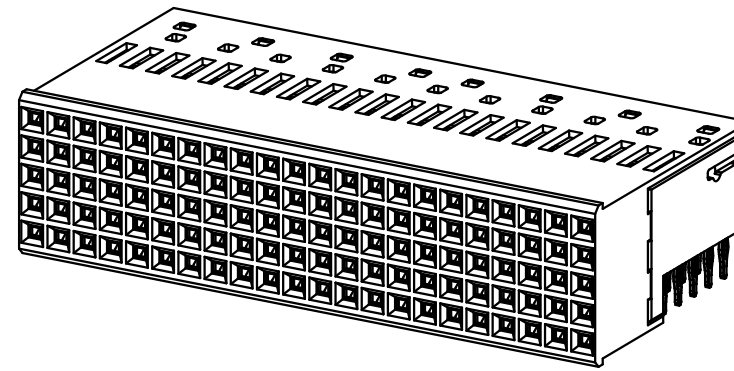
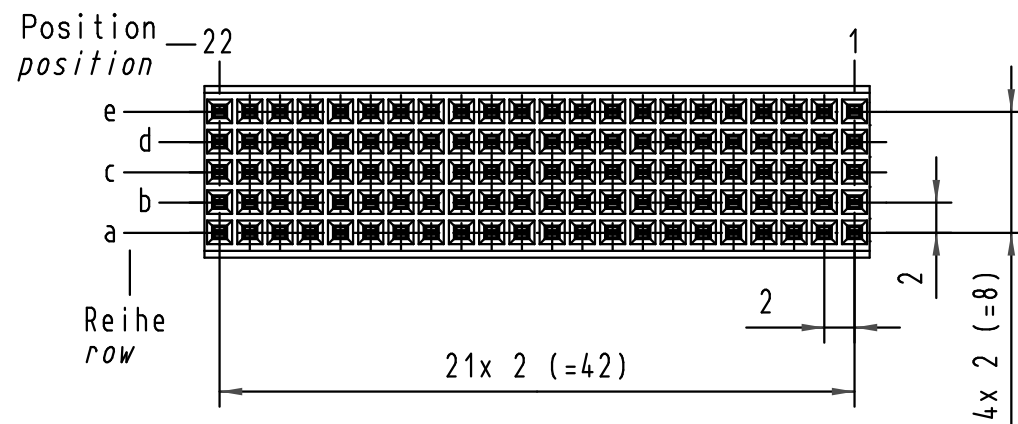
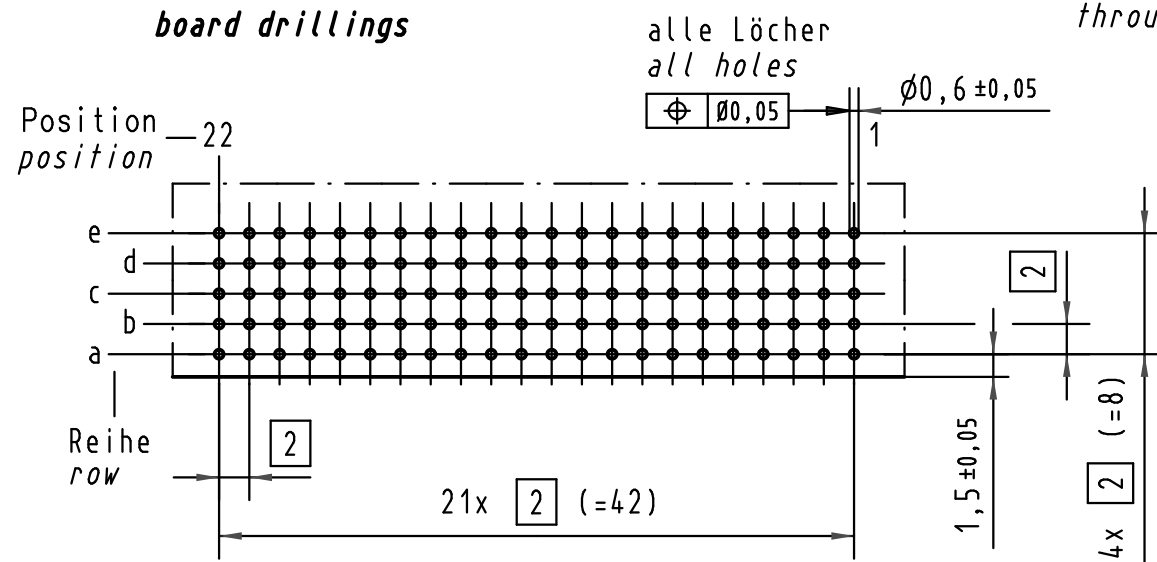
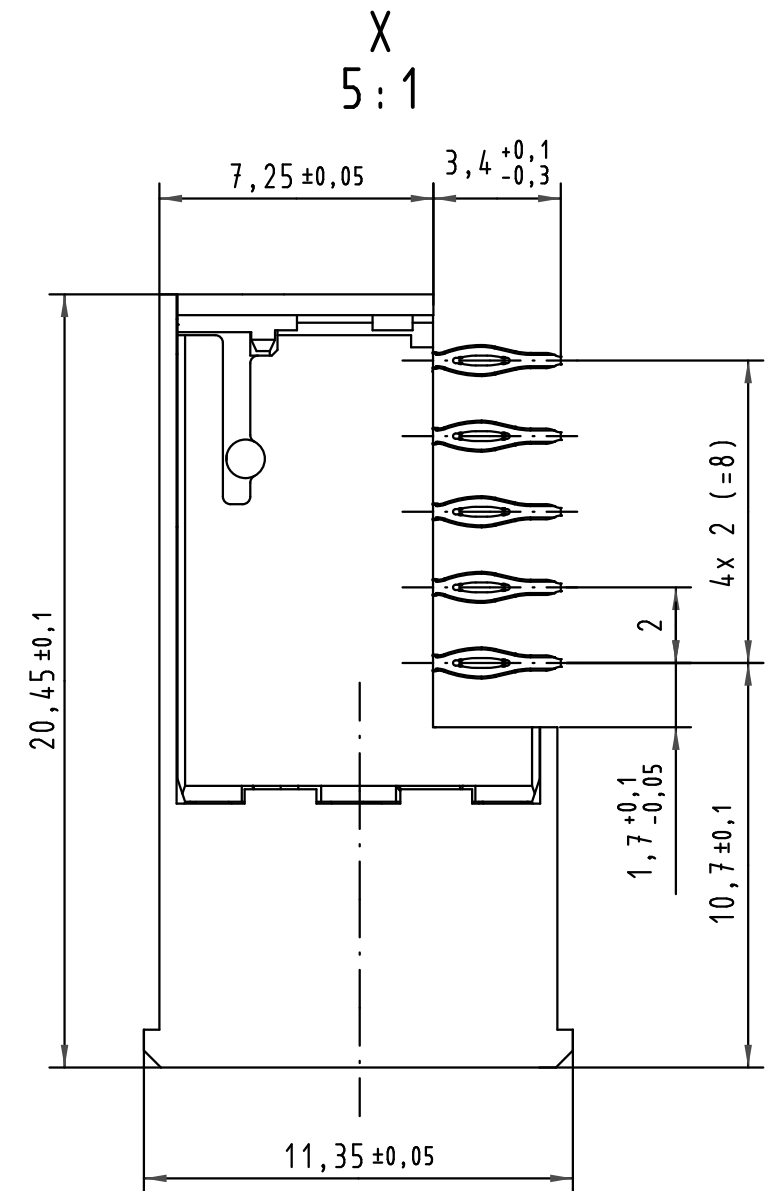




Lochbild
board drillings



Bohrlochdurchmesser: $\varnothing 0,7 \pm 0,02$ mm
Lochdurchmesser (mit Oberfläche): $\varnothing 0,6 \pm 0,05$ mm
drill hole dia.: $\varnothing 0,7 \pm 0,02$ mm
through hole dia. (after plating): $\varnothing 0,6 \pm 0,05$ mm



17 24 110 4101	—	min.0,76µm (30µin) Au über/over min.1,27µm (50µin) Ni
17 24 110 2101	2	Au über/over Ni
17 24 110 1101	1	Au über/over Ni
Bestell-Nr. part-no.	Anforderungsstufe nach IEC performance level acc. to IEC	Kontaktoberfläche contact plating

			All Dimensions in mm Original Size DIN A 3			Techn. Character.			Nicht tolerierte Maße/Free size tolerances IEC 61076-4-101		
34650	04.02.08	Hage.		Dat.	Name	Maßstab/Scale 2:1 (5:1)	har-bus HM Federleiste, Typ B22, 110 pol. <i>har-bus HM female connector, type B22, 110 pol.</i>				
30073	03.08.01	Wi	Detail.	30.10.97	Hm						
26047	21.05.99	Hm	Insp.	30.10.97	Ko						
25017	22.09.98	Hm	Stand.								
24594	10.08.98	Hm									
22833			HARTING Electronics GmbH & Co. KG D-32339 ESPELKAMP				TB 17 24 110 x101		Blatt/ page /		
Mod.	Dat.	Name					Sub.				